BC846T SERIES BC847T SERIES



SOT-523 CASE

ULTRAmini[™]



www.centralsemi.com

DESCRIPTION:

The CENTRAL SEMICONDUCTOR BC846T and BC847T Series types are NPN Silicon Transistors manufactured by the epitaxial planar process, epoxy molded in a surface mount package, designed for general purpose switching and amplifier applications.

MARKING CODE: SEE MARKING CODE TABLE ON FOLLOWING PAGE

Collector-Base Collector-Emitter-Base Continuous Continuous Content Peak Collector Peak Base Cur Power Dissipat	er Voltage /oltage /lector Current Current rrent tion Storage Junction Temperature	SYMBOL VCBO VCEO VEBO IC ICM IBM PD TJ, Tstg ΘJA	50 45	80 65 5.0 100 200 100 250 65 to +150 500	UNITS V V MA MA MA MV °C °C/W
ELECTRICAL SYMBOL ICBO ICBO ICBO BVCBO BVCBO BVCEO BVCEO BVEBO VCE(SAT) VCE(SAT) VBE(ON) FT CC CC NF	CHARACTERISTICS: (T _A =25°C un TEST CONDITIONS VCB=30V VCB=30V, T _A =150°C VEB=5.0V IC=10µA (BC847T) IC=10µA (BC846T) IC=10mA (BC846T) IC=10mA (BC846T) IE=10µA IC=10mA, I _B =0.5mA IC=100mA, I _B =5.0mA IC=100mA, VCE=5.0V IC=10mA, VCE=5.0V VCE=5.0V, IC=10mA, f=100MHz VCB=10V, I _C =0, f=1.0MHz VCB=0.5V, I _C =0, f=1.0MHz VCE=5.0V, I _C =200µA, RS=2.0KΩ f=1.0KHz, BW=200Hz	50 80 45 65 5.0 0.58 100	TYP	0.20 0.40 0.77 1.5	UNITS nA µA nA V V V V V V MHz pF pF dB
h _{FE}	V _{CE} =5.0V, I _C =2.0mA	MIN MA 110 22		MIN MAX 200 450	MIN MAX 420 800

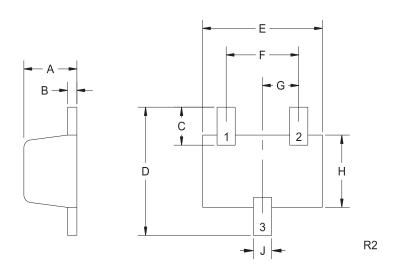
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SOT-523 CASE - MECHANICAL OUTLINE

BOTTOM VIEW



LEAD CODE:

- 1) BASE
- 2) EMITTER
- 3) COLLECTOR

DEVICE	MARKING CODE		
BC846AT	GT1		
BC846BT	GT2		
BC847AT	GT3		
BC847BT	GT4		
BC847CT	GT5		

DIMENSIONS							
	INCHES		MILLIMETERS				
SYMBOL	MIN	MAX	MIN	MAX			
Α	0.023	0.031	0.58	0.78			
В	0.002	0.008	0.04	0.20			
С	0.013	0.021	0.34	0.54			
D	0.059	0.067	1.50	1.70			
Е	0.059	0.067	1.50	1.70			
F	0.035	0.043	0.90	1.10			
G	0.020		0.50				
Н	0.031	0.039	0.78	0.98			
J	0.010	0.014	0.25	0.35			

SOT-523 (REV: R2)

R1 (20-November 2009)

OUTSTANDING SUPPORT AND SUPERIOR SERVICES



PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- · Inventory bonding
- · Consolidated shipping options

- · Custom bar coding for shipments
- · Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- · Custom electrical curves
- · Environmental regulation compliance
- · Customer specific screening
- · Up-screening capabilities

- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits
- · Custom product and package development

REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

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